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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	50MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	24
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.25V
Data Converters	A/D 24x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f410-gq

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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1.13. Programmable Counter Array

The Programmable Counter Array (PCA0) provides enhanced timer functionality while requiring less CPU intervention than the standard 8051 counter/timers. The PCA consists of a dedicated 16-bit counter/timer and six 16-bit capture/compare modules. The counter/timer is driven by a programmable timebase that can select between seven sources: system clock, system clock divided by four, system clock divided by twelve, the external oscillator clock source divided by 8, real-time clock source divided by 8, Timer 0 overflow, or an external clock signal on the External Clock Input (ECI) pin.

Each capture/compare module may be configured to operate independently in one of six modes: Edge-Triggered Capture, Software Timer, High-Speed Output, Frequency Output, 8-Bit PWM, or 16-Bit PWM. Additionally, PCA Module 5 may be used as a watchdog timer (WDT), and is enabled in this mode following a system reset. The PCA Capture/Compare Module I/O and the External Clock Input may be routed to Port I/O using the digital crossbar.



Figure 1.12. PCA Block Diagram



NOTES:



5.4.1. Window Detector In Single-Ended Mode

Figure 5.7 shows two example window comparisons for right-justified data with ADC0LTH:ADC0LTL = 0x0200 (512d) and ADC0GTH:ADC0GTL = 0x0100 (256d). The input voltage can range from '0' to V_{REF} x (4095/4096) with respect to GND, and is represented by a 12-bit unsigned integer value. The repeat count is set to one. In the left example, an AD0WINT interrupt will be generated if the ADC0 conversion word (ADC0H:ADC0L) is within the range defined by ADC0GTH:ADC0GTL and ADC0LTH:ADC0LTL (if 0x0100 < ADC0H:ADC0L < 0x0200). In the right example, and AD0WINT interrupt will be generated if the ADC0 conversion word is outside of the range defined by the ADC0GT and ADC0LT registers (if ADC0H:ADC0L < 0x0100 or ADC0H:ADC0L > 0x0200). Figure 5.8 shows an example using left-justified data with the same comparison values.



Figure 5.7. ADC Window Compare Example: Right-Justified Single-Ended Data



Figure 5.8. ADC Window Compare Example: Left-Justified Single-Ended Data



Table 5.4. ADC0 Electrical Characteristics (V_{DD} = 2.1 V, V_{REF} = 1.5 V)

 V_{DD} = 2.1 V, V_{REF} = 1.5 V (REFSL = 0), -40 to +85 °C unless otherwise specified. Typical values are given at 25 °C.

Parameter	Conditions	Min	Тур	Max	Units
DC Accuracy	1				
Resolution			12		bits
Integral Nonlinearity				±1	LSB
Differential Nonlinearity	Guaranteed Monotonic	_		±1	LSB
Offset Error		—	±3	±10	LSB
Full Scale Error		—	±3	±10	LSB
Dynamic Performance (10 kHz s	sine-wave Single-ended input, 0	to 1 dE	B below	Full Sca	ale, 200 ksps)
Signal-to-Noise Plus Distortion	Regular Mode (BURSTEN = '0') Burst Mode (BURSTEN = '0')	66 60	68 62	_	dB
Total Harmonic Distortion	Up to the 5 th harmonic	—	-75		dB
Spurious-Free Dynamic Range		_	-90		dB
Conversion Rate	1				
SAR Conversion Clock	Regular Mode (BURSTEN = '0')			3	MHz
Conversion Time in SAR Clocks ¹			13	—	clocks
Track/Hold Acquisition Time ²		1	_	—	μs
Throughput Rate		_		200	ksps
Analog Inputs					
Input Voltage Range		0		V _{REF}	V
Input Capacitance		_	12		pF
Temperature Sensor					
Linearity ^{3,4}			±0.2	—	°C
Slope ⁴			2.95	_	mV/°C
Slope Error ³			±73	—	μV/°C
Offset	(Temp = 0 °C)	—	900		mV
Offset Error ³			±17	—	mV
Power Specifications					
Power Supply Current (V _{DD} supplied to ADC0)	Operating Mode, 200 ksps	_	650	1000	μA
Burst Mode (Idle)		_	100	—	μA
Power Supply Rejection		_	1	—	mV/V
Neteo					

Notes:

1. An additional 2 FCLK cycles are required to start and complete a conversion.

 Additional tracking time may be required depending on the output impedance connected to the ADC input. See Section "5.3.6. Settling Time Requirements" on page 58.

3. Represents one standard deviation from the mean.

4. Includes ADC offset, gain, and linearity variations.



SFR Definition	6.1.	IDA0CN:	IDA0	Control
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R/W	R/W	R/W	R/W	R/W	R	R/W	R/W	Reset Value
IDA0EN	1	IDA0CM		-	IDAORJST	IDA		01110011
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
							SFR Addres	ss: 0xB9
Bit 7:	IDA0EN: ID	A0 Enable B	it.					
	0: IDA0 Dis	abled.						
	1: IDA0 Ena	abled.						
Bits 6-4:	IDA0CM[2:	0]: IDA0 Upd	ate Source	Select Bits	6.			
	000: DAC c	output update	s on Timer	0 overflow				
	001: DAC c	output update	s on Timer	1 overflow				
	010: DAC c	output update	s on Timer	2 overflow				
	011: DAC o	output update	s on Timer	3 overflow				
	100: DAC c	output update	s on rising	edge of CN	NVSTR.			
	101: DAC c	output update	s on falling	edge of C	NVSTR.			
	110: DAC o	output update	s on any e	dge of CN∖	/STR.			
	111: DAC o	utput updates	s on write t	o IDA0H.				
Bit 3:	Reserved. I	Read = 0b, W	/rite = 0b.					
Bit 2:	IDA0RJST:	IDA0 Right J	ustify Sele	ct Bit.				
	0: IDA0 dat	a in IDA0H:II	DAOL is left	justified.				
	1: IDA0 dat	a in IDA0H:II	DAOL is rigl	ht justified.				
Bits 1:0:	IDA00MD[1:0]: IDA0 Ou	tput Mode	Select Bits	i.			
	00: 0.25 m/	A full-scale οι	utput currer	nt.				
	01: 0.5 mA	full-scale out	put current	i.				
	10: 1.0 mA	full-scale out	put current					
	11: 2.0 mA	full-scale out	put current					

SFR Definition 6.2. IDA0H: IDA0 Data High Byte







Figure 9.3. Comparator Hysteresis Plot

The Comparator hysteresis is software-programmable via its Comparator Control register CPTnCN (for n = 0 or 1). The user can program both the amount of hysteresis voltage (referred to the input voltage) and the positive and negative-going symmetry of this hysteresis around the threshold voltage.

The Comparator hysteresis is programmed using Bits3-0 in the Comparator Control Register CPTnCN (shown in SFR Definition 9.1 and SFR Definition 9.6). The amount of negative hysteresis voltage is determined by the settings of the CPnHYN bits. As shown in Table 9.1, settings of 20, 10 or 5 mV of negative hysteresis can be programmed, or negative hysteresis can be disabled. In a similar way, the amount of positive hysteresis is determined by setting the CPnHYP bits.

Comparator interrupts can be generated on both rising-edge and falling-edge output transitions. (For Interrupt enable and priority control, see **Section "12. Interrupt Handler" on page 110**). The CPnFIF flag is set to logic 1 upon a Comparator falling-edge detect, and the CPnRIF flag is set to logic 1 upon the Comparator rising-edge detect. Once set, these bits remain set until cleared by software. The output state of the Comparator can be obtained at any time by reading the CPnOUT bit. The Comparator is enabled by setting the CPnEN bit to logic 1, and is disabled by clearing this bit to logic 0.

The output state of the Comparator can be obtained at any time by reading the CPnOUT bit. The Comparator is enabled by setting the CPnEN bit to logic 1, and is disabled by clearing this bit to logic 0. When the Comparator is enabled, the internal oscillator is awakened from SUSPEND mode if the Comparator output is logic 0.

Note that false rising edges and falling edges can be detected when the comparator is first powered-on or if changes are made to the hysteresis or response time control bits. Therefore, it is recommended that the rising-edge and falling-edge flags be explicitly cleared to logic 0 a short time after the comparator is enabled or its mode bits have been changed. This Power Up Time is specified in Table 9.1 on page 92.



R/W	R	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value	
CPOEN		CPORIF	CP0FIF	CP0HYP1	CP0HYP0	CP0HYN1	CP0HYN0	00000000	
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:	
								0x9B	
Bit7:	CP0EN: Cor	nparator0 E	nable Bit.						
	0: Comparat	or0 Disable	d.						
Bit6.		oru Enable	J. Output Sta	to Flog					
DILO.	0: Voltage or	CP0 + < C	P0_	ile Flay.					
	1: Voltage or	1 CP0 + < 0 1 CP0 + > C	P0						
Bit5:	CP0RIF: Co	mparator0	Rising-Edg	e Flag.					
	0: No Compa	arator0 Risi	ng Edge ha	as occurred	since this fl	ag was last	cleared.		
	1: Comparat	or0 Rising I	Edge has o	ccurred.					
Bit4:	CP0FIF: Cor	nparator0 F	alling-Edg	e Flag.					
	0: No Compa	arator0 Fall	Ing-Edge h	as occurred	I since this f	lag was last	cleared.		
Rite3_2		oro Failing-	Edge has o	o Hystoresi	e Control Bi	te			
DII33-2.	00: Positive Hysteresis Disabled								
	01: Positive	Hvsteresis	= 5 mV.						
	10: Positive	Hysteresis	= 10 mV.						
	11: Positive I	Hysteresis	= 20 mV.						
Bits1–0:	CP0HYN1-C): Compara	tor0 Negati	ve Hysteres	sis Control E	Bits.			
	00: Negative	Hysteresis	Disabled.						
	01: Negative	Hysteresis	= 5 mV.						
	10. Negative	Hysteresis	= 10 mV						
		1, 1, 01010010	20						

SFR Definition 9.1. CPT0CN: Comparator0 Control



10.3.1. Idle Mode

Setting the Idle Mode Select bit (PCON.0) causes the CIP-51 to halt the CPU and enter Idle mode as soon as the instruction that sets the bit completes execution. All internal registers and memory maintain their original data. All analog and digital peripherals can remain active during Idle mode.

Idle mode is terminated when an enabled interrupt is asserted or a reset occurs. The assertion of an enabled interrupt will cause the Idle Mode Selection bit (PCON.0) to be cleared and the CPU to resume operation. The pending interrupt will be serviced and the next instruction to be executed after the return from interrupt (RETI) will be the instruction immediately following the one that set the Idle Mode Select bit. If Idle mode is terminated by an internal or external reset, the CIP-51 performs a normal reset sequence and begins program execution at address 0x0000.

If enabled, the Watchdog Timer (WDT) will eventually cause an internal watchdog reset and thereby terminate the Idle mode. This feature protects the system from an unintended permanent shutdown in the event of an inadvertent write to the PCON register. If this behavior is not desired, the WDT may be disabled by software prior to entering the Idle mode if the WDT was initially configured to allow this operation. This provides the opportunity for additional power savings, allowing the system to remain in the Idle mode indefinitely, waiting for an external stimulus to wake up the system.

10.3.2. Stop Mode

Setting the Stop Mode Select bit (PCON.1) causes the CIP-51 to enter Stop mode as soon as the instruction that sets the bit completes execution. In Stop mode the internal oscillator, CPU, and all digital peripherals are stopped; the state of the external oscillator circuit is not affected. Each analog peripheral (including the external oscillator circuit) may be shut down individually prior to entering Stop Mode. Stop mode can only be terminated by an internal or external reset. On reset, the CIP-51 performs the normal reset sequence and begins program execution at address 0x0000.

If enabled, the Missing Clock Detector will cause an internal reset and thereby terminate the Stop mode. The Missing Clock Detector should be disabled if the CPU is to be put to in STOP mode for longer than the MCD timeout period of 100 μ s.

10.3.3. Suspend Mode

The C8051F41x devices feature a low-power SUSPEND mode, which stops the internal oscillator until a wakening event occurs. See Section "19.1.1. Internal Oscillator Suspend Mode" on page 166.

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value		
Reserve	d Reserved	Reserved	Reserved	Reserved	Reserved	STOP	IDLE	0000000		
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	_		
							SFR Addres	s: 0x87		
Bits7–2: Bit1: Bit0:	 Bits7–2: Reserved. Bit1: STOP: STOP Mode Select. Writing a '1' to this bit will place the CIP-51 into STOP mode. This bit will always read '0'. 1: CIP-51 forced into power-down mode. (Turns off internal oscillator). Bit0: IDLE: IDLE Mode Select. Writing a '1' to this bit will place the CIP-51 into IDLE mode. This bit will always read '0'. 1: CIP-51 forced into IDLE mode. (Shuts off clock to CPU, but clock to Timers, Interrupts, and all peripherals remain active.) 									

SFR Definition 10.7. PCON: Power Control



Table 11.2. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved.

Register	Address	Description	Page
IDA1L	0xF4	Current Mode DAC1 Low Byte	73
IDA1CN	0xB5	Current Mode DAC1 Control	72
IE	0xA8	Interrupt Enable	112
IP	0xB8	Interrupt Priority	113
IT01CF	0xE4	INT0/INT1 Configuration	118
ONESHOT	0xAF	Flash Oneshot Period	143
OSCICL	0xB3	Internal Oscillator Calibration	167
OSCICN	0xB2	Internal Oscillator Control	167
OSCXCN	0xB1	External Oscillator Control	171
P0	0x80	Port 0 Latch	155
POMASK	0xC7	Port 0 Mask	157
POMAT	0xD7	Port 0 Match	157
POMDIN	0xF1	Port 0 Input Mode Configuration	155
P0MDOUT	0xA4	Port 0 Output Mode Configuration	156
POODEN	0xB0	Port 0 Overdrive	157
P0SKIP	0xD4	Port 0 Skip	156
P1	0x90	Port 1 Latch	158
P1MASK	0xBF	Port 1 Mask	160
P1MAT	0xCF	Port 1 Match	160
P1MDIN	0xF2	Port 1 Input Mode Configuration	158
P1MDOUT	0xA5	Port 1 Output Mode Configuration	159
P1SKIP	0xD5	Port 1 Skip	159
P2	0xA0	Port 2 Latch	161
P2MDIN	0xF3	Port 2 Input Mode Configuration	161
P2MDOUT	0xA6	Port 2 Output Mode Configuration	162
P2SKIP	0xD6	Port 2 Skip	162
PCA0CN	0xD8	PCA Control	261
PCA0CPH0	0xFC	PCA Capture 0 High	264
PCA0CPH1	0xEA	PCA Capture 1 High	264
PCA0CPH2	0xEC	PCA Capture 2 High	264
PCA0CPH3	0xEE	PCA Capture 3 High	264
PCA0CPH4	0xFE	PCA Capture 4 High	264
PCA0CPH5	0xD3	PCA Capture 5 High	264
PCA0CPL0	0xFB	PCA Capture 0 Low	264
PCA0CPL1	0xE9	PCA Capture 1 Low	264
PCA0CPL2	0xEB	PCA Capture 2 Low	264
PCA0CPL3	0xED	PCA Capture 3 Low	264
PCA0CPL4	0xFD	PCA Capture 4 Low	264



14. Cyclic Redundancy Check Unit (CRC0)

C8051F41x devices include a cyclic redundancy check unit (CRC0) that can perform a CRC using a 16-bit or 32-bit polynomial. CRC0 accepts a stream of 8-bit data written to the CRC0IN register. CRC0 posts the 16-bit or 32-bit result to an internal register. The internal result register may be accessed indirectly using the CRC0PNT bits and CRC0DAT register, as shown in Figure 14.1. CRC0 also has a bit reverse register for quick data manipulation.



Figure 14.1. CRC0 Block Diagram

14.1. 16-bit CRC Algorithm

The C8051F41x CRC unit calculates the 16-bit CRC MSB-first, using a poly of 0x1021. The following describes the 16-bit CRC algorithm performed by the hardware:

- Step 1. XOR the most-significant byte of the current CRC result with the input byte. If this is the first iteration of the CRC unit, the current CRC result will be the set initial value (0x0000 or 0xFFFF).
- Step 2a. If the MSB of the CRC result is set, left-shift the CRC result, and then XOR the CRC result with the polynomial (0x1021).
- Step 2b. If the MSB of the CRC result is not set, left-shift the CRC result.
- Step 3. Repeat at Step 2a for the number of input bits (8).



Input	Output
0x63	0xF9462090
0xAA, 0xBB, 0xCC	0x41B207B3
0x00, 0x00, 0xAA, 0xBB, 0xCC	0x78D129BC

Table 14.2. Example 32-bit CRC Outputs

14.3. Preparing for a CRC Calculation

To prepare CRC0 for a CRC calculation, software should select the desired polynomial and set the initial value of the result. Two polynomials are available: 0x1021 (16-bit) and 0x04C11DB7 (32-bit). The CRC0 result may be initialized to one of two values: 0x00000000 or 0xFFFFFFFF. The following steps can be used to initialize CRC0.

- Step 1. Select a polynomial (Set CRC0SEL to '0' for 32-bit or '1' for 16-bit).
- Step 2. Select the initial result value (Set CRC0VAL to '0' for 0x0000000 or '1' for 0xFFFFFFF). Step 3. Set the result to its initial value (Write '1' to CRC0INIT).

14.4. Performing a CRC Calculation

Once CRC0 is initialized, the input data stream is sequentially written to CRC0IN, one byte at a time. The CRC0 result is automatically updated after each byte is written.

14.5. Accessing the CRC0 Result

The internal CRC0 result is 32-bits (CRC0SEL = 0b) or 16-bits (CRC0SEL = 1b). The CRC0PNT bits select the byte that is targeted by read and write operations on CRC0DAT and increment after each read or write. The calculation result will remain in the internal CRC0 result register until it is set, overwritten, or additional data is written to CRC0IN.

14.6. CRC0 Bit Reverse Feature

CRC0 includes hardware to reverse the bit order of each bit in a byte as shown in Figure 14.2. Each byte of data written to CRC0FLIP is read back bit reversed. For example, if 0xC0 is written to CRC0FLIP, the data read back is 0x03.



Figure 14.2. Bit Reverse Register



18. Port Input/Output

Digital and analog resources are available through up to 24 I/O pins. Port pins are organized as three bytewide Ports. Each of the Port pins can be defined as general-purpose I/O (GPIO) or analog input/output; Port pins P0.0 - P2.7 can be assigned to one of the internal digital resources as shown in Figure 18.3. The designer has complete control over which functions are assigned, limited only by the number of physical I/O pins. This resource assignment flexibility is achieved through the use of a Priority Crossbar Decoder. Note that the state of a Port I/O pin can always be read in the corresponding Port latch, regardless of the Crossbar settings.

The Crossbar assigns the selected internal digital resources to the I/O pins based on the peripheral priority order of the Priority Decoder (Figure 18.3 and Figure 18.4). The registers XBR0 and XBR1, defined in SFR Definition 18.1 and SFR Definition 18.2, are used to select internal digital functions.

Port I/Os on P0 are 5 V tolerant over the operating range of V_{IO} . Port I/Os on P1 and P2 should not be driven above V_{IO} or they will sink current. Figure 18.2 shows the Port cell circuit. The Port I/O cells are configured as either push-pull or open-drain in the Port Output Mode registers (PnMDOUT, where n = 0,1,2). Complete Electrical Specifications for Port I/O are given in Table 18.1 on page 163.









Figure 18.5. Port 0 Input Overdrive Current Range

The output driver characteristics of the I/O pins are defined using the Port Output Mode registers (PnMD-OUT). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. The only exception to this is the SMBus (SDA, SCL) pins, which are configured as open-drain regardless of the PnMDOUT settings. When the WEAKPUD bit in XBR1 is '0', a weak pullup is enabled for all Port I/O configured as open-drain. WEAKPUD does not affect the push-pull Port I/O. Furthermore, the weak pullup is turned off on an output that is driving a '0' and for pins configured for analog input mode to avoid unnecessary power dissipation.

Registers XBR0 and XBR1 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR1 to '1' enables the Crossbar. Until the Crossbar is enabled, the external pins remain as standard Port I/O (in input mode), regardless of the XBRn Register settings. For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table.

The Crossbar must be enabled to use Port pins as standard Port I/O in output mode. Port output drivers are disabled while the Crossbar is disabled.



SFR Definition 18.14. P1MAT: Port1 Match



SFR Definition 18.15. P1MASK: Port1 Mask





SMBus configuration options include:

- Timeout detection (SCL Low Timeout and/or Bus Free Timeout)
- SDA setup and hold time extensions
- Slave event enable/disable
- Clock source selection

These options are selected in the SMB0CF register, as described in **Section "21.4.1. SMBus Configura**tion Register" on page 195.

21.4.1. SMBus Configuration Register

The SMBus Configuration register (SMB0CF) is used to enable the SMBus Master and/or Slave modes, select the SMBus clock source, and select the SMBus timing and timeout options. When the ENSMB bit is set, the SMBus is enabled for all master and slave events. Slave events may be disabled by setting the INH bit. With slave events inhibited, the SMBus interface will still monitor the SCL and SDA pins; however, the interface will NACK all received addresses and will not generate any slave interrupts. When the INH bit is set, all slave events will be inhibited following the next START (interrupts will continue for the duration of the current transfer).

SMBCS1	SMBCS0	SMBus Clock Source
0	0	Timer 0 Overflow
0	1	Timer 1 Overflow
1	0	Timer 2 High Byte Overflow
1	1	Timer 2 Low Byte Overflow

Table 21.1. SMBus Clock Source Selection

The SMBCS1-0 bits select the SMBus clock source, which is used only when operating as a master or when the Bus Free Timeout detection is enabled. When operating as a master, overflows from the selected source determine the absolute minimum SCL low and high times as defined in Equation 21.1. Note that the selected clock source may be shared by other peripherals so long as the timer is left running at all times. For example, Timer 1 overflows may generate the SMBus and UART baud rates simultaneously. Timer configuration is covered in Section "24. Timers" on page 231.

$$T_{HighMin} = T_{LowMin} = \frac{1}{f_{ClockSourceOverflow}}$$

Equation 21.1. Minimum SCL High and Low Times

The selected clock source should be configured to establish the minimum SCL High and Low times as per Equation 21.1. When the interface is operating as a master (and SCL is not driven or extended by any other devices on the bus), the typical SMBus bit rate is approximated by Equation 21.2.

$$BitRate = \frac{f_{ClockSourceOverflow}}{3}$$

Equation 21.2. Typical SMBus Bit Rate



R/W	R	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
S0MOD	E -	MCE0	REN0	TB80	RB80	TI0	RI0	01000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Bit
							SER Address	· OxQ8
							SI IX Addiess	. 07.00
Bit7:	S0MODE: S	erial Port 0	Operation	Mode.				
	This bit sele	cts the UAF	RT0 Operati	on Mode.				
	0: 8-bit UAR	T with Varia	able Baud R	Rate.				
Bit6 [.]	UNUSED R	r with vana ead = 1b V	Vrite = don'	t care				
Bit5:	MCE0: Multi	processor (Communica	tion Enable				
	The function	of this bit is	s depender	it on the Se	rial Port 0 C	peration M	ode.	
	S0MODE =	0: Checks f	or valid sto	o bit.				
	0: Lo	ogic level of	f stop bit is	ignored.				
		IU WIII ONIY I 1 · Multiproc	be activated	I IT STOP DIT	s logic leve Enable	11.		
	0: Lo	aic level of	f ninth bit is	ianored.				
	1: R	I0 is set and	d an interru	pt is genera	ted only wh	en the nint	h bit is logic	1.
Bit4:	REN0: Rece	ive Enable.			-		-	
	This bit enab	oles/disable	s the UART	receiver.				
		ception dis	abled.					
Bit3	TB80 [·] Ninth	Transmissi	on Bit					
Dito.	The logic lev	el of this bi	t will be ass	igned to the	e ninth trans	mission bit	in 9-bit UAF	RT Mode. It
	is not used in	n 8-bit UAR	T Mode. S	Set or cleare	ed by softwa	are as requi	red.	
Bit2:	RB80: Ninth	Receive Bi	t.					
	RB80 is assi	gned the va	alue of the S	STOP bit in	Mode 0; it i	s assigned	the value of	f the 9th
Rit1.	TIO: Transmi	00e 1. It Interrunt F	-lan					
DITT.	Set by hardy	vare when a	a byte of da	ta has beer	n transmitte	d by UART) (after the 8	8th bit in 8-
	bit UART Mo	de, or at th	e beginning	of the STC	P bit in 9-bi	it UART Mo	de). When t	the UART0
	interrupt is e	nabled, set	ting this bit	causes the	CPU to vec	tor to the U	ART0 interr	upt service
BHA	routine. This	bit must be	e cleared m	anually by s	software.			
Bit0:	RI0: Receive	e Interrupt F	·lag.	of data haa	haan raaaiy	od by LIAD	TO (act at th	
	sampling tim	e) When the	he UART0 i	nterrunt is e	enabled set	ting this bit	to '1' cause	e STOP bit
	to vector to t	he UART0	interrupt se	rvice routin	e. This bit m	nust be clea	ared manual	lly by soft-
	ware.							-

SFR Definition 22.1. SCON0: Serial Port 0 Control





* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.





* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 23.9. SPI Slave Timing (CKPHA = 1)



25.3.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS2-CPS0) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 5 is forced into software timer mode.
- Writes to the Module 5 mode register (PCA0CPM5) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH5 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH5. Upon a PCA0CPH5 write, PCA0H plus the offset held in PCA0CPL5 is loaded into PCA0CPH5 (See Figure 25.10).



Figure 25.10. PCA Module 5 with Watchdog Timer Enabled



26. C2 Interface

C8051F41x devices include an on-chip Silicon Laboratories 2-Wire (C2) debug interface to allow Flash programming and in-system debugging with the production part installed in the end application. The C2 interface uses a clock signal (C2CK) and a bi-directional C2 data signal (C2D) to transfer information between the device and a host system. See the C2 Interface Specification for details on the C2 protocol.

26.1. C2 Interface Registers

The following describes the C2 registers necessary to perform Flash programming functions through the C2 interface. All C2 registers are accessed through the C2 interface as described in the C2 Interface Specification.



C2 Register Definition 26.1. C2ADD: C2 Address

C2 Register Definition 26.2. DEVICEID: C2 Device ID



